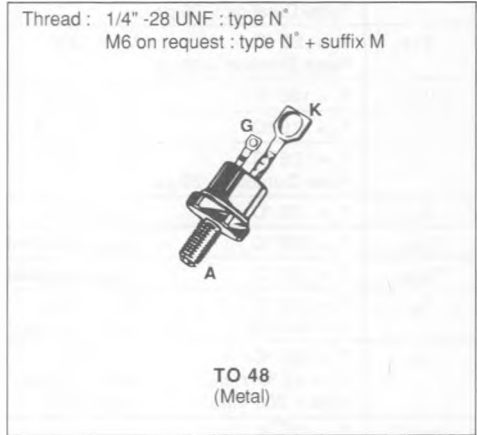




FAST SWITCHING THYRISTORS

- GLASS PASSIVATED CHIP
- HIGH STABILITY AND RELIABILITY
- HIGH di/dt AND dv/dt RATINGS
- $t_q \leq 10 \mu s$



DESCRIPTION

SCR designed for high frequency power switching applications.

ABSOLUTE RATINGS (limiting values)

Symbol	Parameter	Value	Unit
$I_{T(RMS)}$	RMS on-state Current (1)	$T_C = 40 \text{ }^\circ\text{C}$ 35	A
$I_{T(AV)}$	Mean on-state Current (1)	$T_C = 40 \text{ }^\circ\text{C}$ 22.5	A
I_{TSM}	Non Repetitive Surge Peak on-state Current (T_J initial $\leq 120 \text{ }^\circ\text{C}$) (2)	$t = 8.3 \text{ ms}$	210
		$t = 10 \text{ ms}$	200
I^2t	I^2t Value for Fusing	$t = 10 \text{ ms}$ 200	A^2s
di/dt	Critical Rate of Rise of on-state Current (3)	400	$A/\mu s$
T_{stg} T_J	Storage and Operating Junction Temperature Range	- 65 to 150	$^\circ\text{C}$
		- 65 to 120	$^\circ\text{C}$

Symbol	Parameter	2N 36..					Unit
		54	55	56	57	58	
V_{DRM} V_{RRM}	Repetitive Peak off-state Voltage (4)	50	100	200	300	400	V

(1) Single phase circuit, 180° conduction angle.

(2) Half sine wave.

(3) $I_G = 1 \text{ A}$ $dv/dt = 1 \text{ A}/\mu s$.

(4) $T_J = 120 \text{ }^\circ\text{C}$.

THERMAL RESISTANCES

Symbol	Parameter	Value	Unit
$R_{th(j-c)}$	Junction-case for D.C.	1.45	$^\circ\text{C}/\text{W}$
$R_{th(c-h)}$	Contact (case to heatsink)	0.40	$^\circ\text{C}/\text{W}$

GATE CHARACTERISTICS (maximum values)

$P_{GM} = 60 \text{ W}$ ($t_p = 500 \mu\text{s}$) $I_{FGM} = 10 \text{ A}$ ($t_p = 500 \mu\text{s}$) $V_{RGM} = 5 \text{ V}$
 $P_{G(AV)} = 1 \text{ W}$ $V_{FGM} = 15 \text{ V}$ ($t_p = 500 \mu\text{s}$)

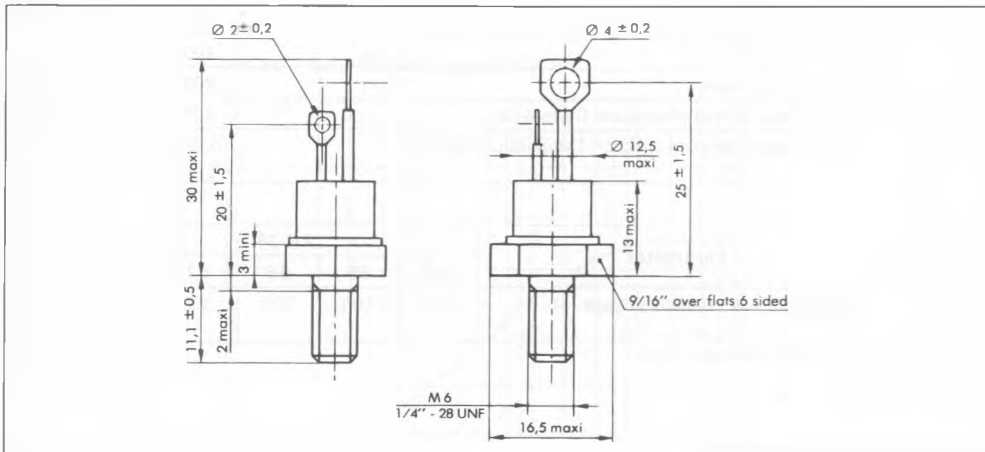
ELECTRICAL CHARACTERISTICS

Symbol	Test Conditions			Min.	Typ.	Max.	Unit
I_{GT}	$T_j = 25 \text{ }^\circ\text{C}$ Pulse Duration > 20 μs	$V_D = 12 \text{ V}$	$R_L = 33 \text{ } \Omega$			180	mA
V_{GT}	$T_j = 25 \text{ }^\circ\text{C}$ Pulse Duration > 20 μs	$V_D = 12 \text{ V}$	$R_L = 33 \text{ } \Omega$			1.5	V
V_{GD}	$T_j = 120 \text{ }^\circ\text{C}$	$V_D = V_{DRM}$	$R_L = 3.3 \text{ k}\Omega$	0.2			V
I_H	$T_j = 25 \text{ }^\circ\text{C}$	$I_T = 500 \text{ mA}$	Gate Open		70		mA
I_L	$T_j = 25 \text{ }^\circ\text{C}$ Pulse Duration > 20 μs	$V_D = 12 \text{ V}$	$I_G = 360 \text{ mA}$		140		mA
V_{TM}	$T_j = 25 \text{ }^\circ\text{C}$	$I_{TM} = 25 \text{ A}$	$t_p = 10 \text{ ms}$			2.05	V
I_{DRM}	$T_j = 120 \text{ }^\circ\text{C}$	V_{DRM} Specified				6	mA
I_{RRM}	$T_j = 120 \text{ }^\circ\text{C}$	V_{RRM} Specified				6	mA
t_{gt}	$T_j = 25 \text{ }^\circ\text{C}$ $I_G = 500 \text{ mA}$	$V_D = V_{DRM}$ $di_G/dt = 5 \text{ A}/\mu\text{s}$	$I_T = 25 \text{ A}$		1		μs
t_{g}	$T_j = 120 \text{ }^\circ\text{C}$ $V_D = 67 \% V_{DRM}$ $dv/dt = 200 \text{ V}/\mu\text{s}$	$I_T = 25 \text{ A}$ $di/dt = 5 \text{ A}/\mu\text{s}$ Gate Open	$V_R = 15 \text{ V}$			10	μs
dv/dt^*	$T_j = 120 \text{ }^\circ\text{C}$	Gate Open Linear Slope up to $V_D = 67 \% V_{DRM}$		200			V/ μs

* For higher guaranteed values, please consult us

PACKAGE MECHANICAL DATA

TO 48 Metal



Cooling method : by conduction (method C)

Marking : type number

Weight : $13.5 \pm 1 \text{ g}$

Polarity : anode to case

Stud torque : $3.5 \text{ mAN min} - 3.8 \text{ mAN max}$.

SINUSOIDAL CURRENT PULSE DATA

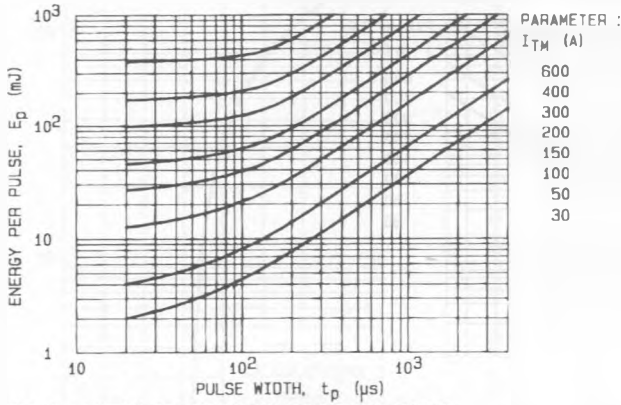


FIG. 1 - ENERGY PER PULSE FOR SINUSOIDAL PULSES.

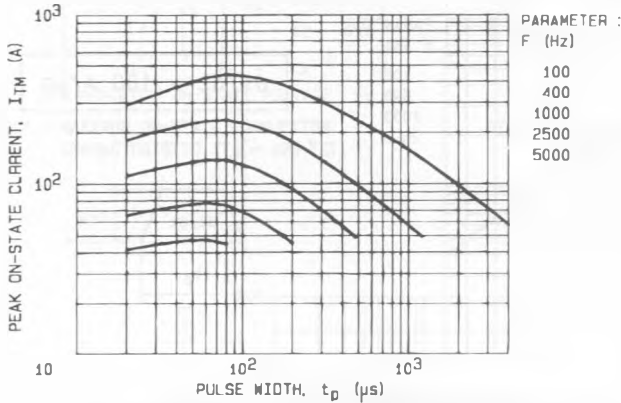


FIG. 2 - MAXIMUM ALLOWABLE PEAK ON-STATE CURRENT VERSUS PULSE WIDTH FOR $T_c = 85^\circ\text{C}$.

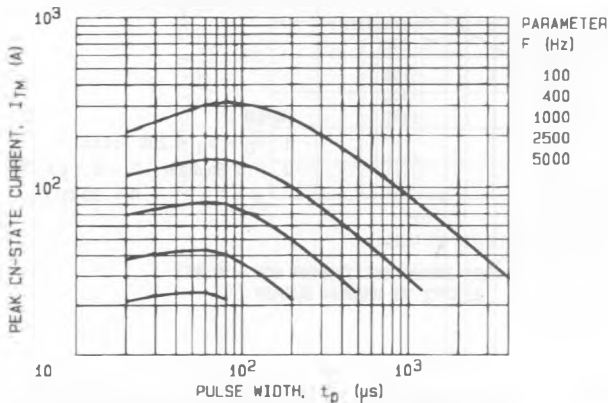
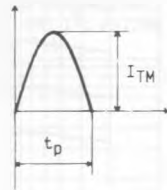


FIG. 3 - MAXIMUM ALLOWABLE PEAK ON-STATE CURRENT VERSUS PULSE WIDTH FOR $T_c = 90^\circ\text{C}$.

NOTES :

1. $V_D = V_R = 200$ volts.
2. R.C Snubber, $C = 0.1\mu\text{F}$,
 $R = 33\Omega$.

TRAPEZOIDAL CURRENT PULSE DATA

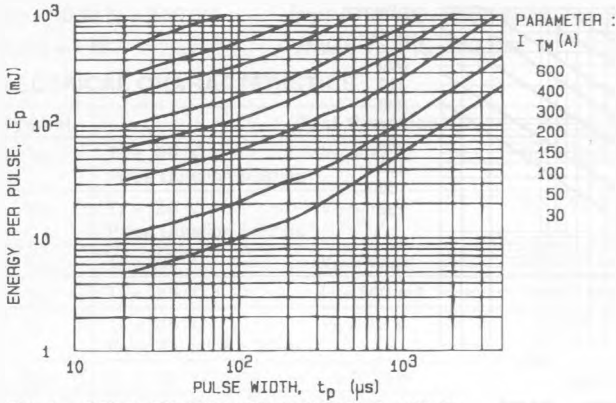
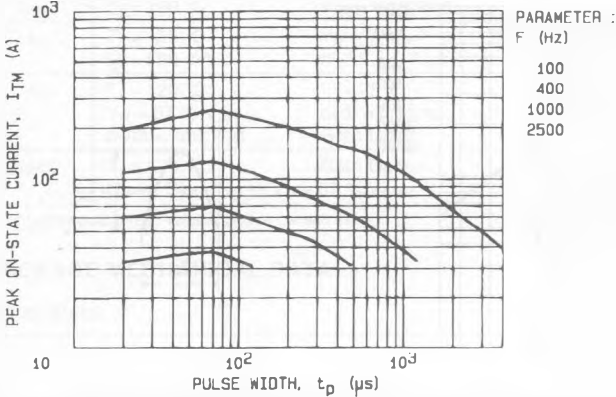


FIG. 4 - ENERGY PER PULSE FOR TRAPEZOIDAL PULSES.



$di/dt = 100 \text{ A}/\mu\text{s}$

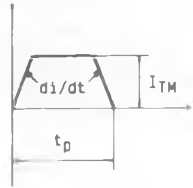


FIG. 5 - MAXIMUM ALLOWABLE PEAK ON-STATE CURRENT VERSUS PULSE WIDTH FOR $T_j = 85^\circ\text{C}$.

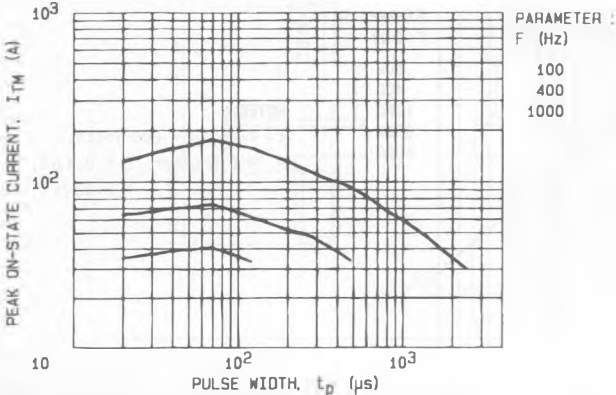


FIG. 6 - MAXIMUM ALLOWABLE PEAK ON-STATE CURRENT VERSUS PULSE WIDTH FOR $T_j = 80^\circ\text{C}$.

NOTES :

1. $V_D = V_R = 200$ Volts.
2. R.C Snubber, $C = 0.1 \mu\text{F}$,
 $R = 33 \Omega$.

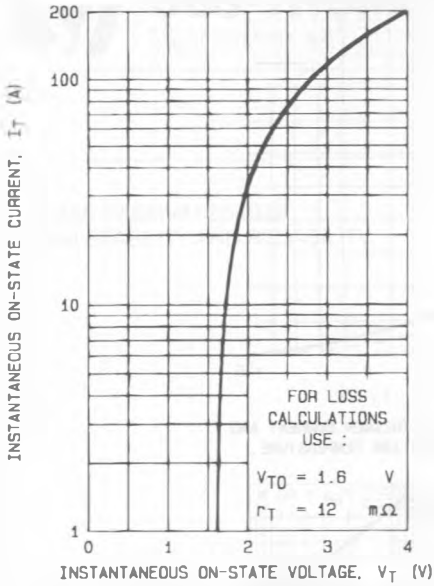


FIG.7 - MAXIMUM ON-STATE CONDUCTION CHARACTERISTIC ($T_J = 120^\circ\text{C}$).

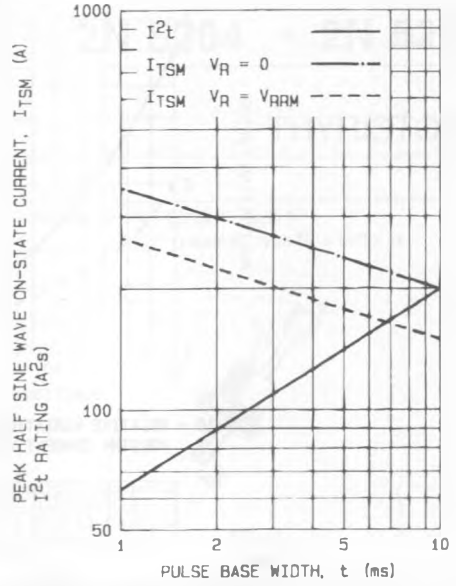


FIG.8 - NON REPETITIVE SUB-CYCLE SURGE ON-STATE CURRENT AND I^2t RATING (INITIAL $T_J = 120^\circ\text{C}$).

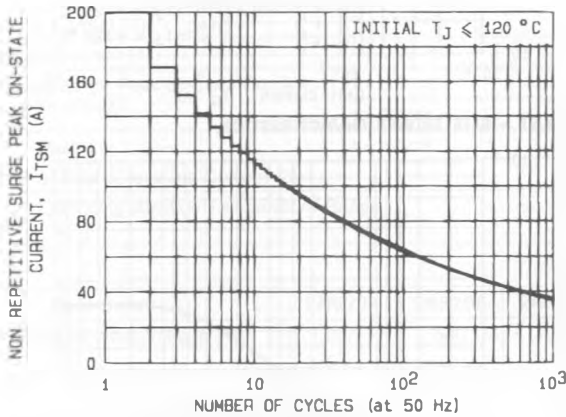


FIG.9 - NON REPETITIVE SURGE PEAK ON-STATE CURRENT VERSUS NUMBER OF CYCLES.

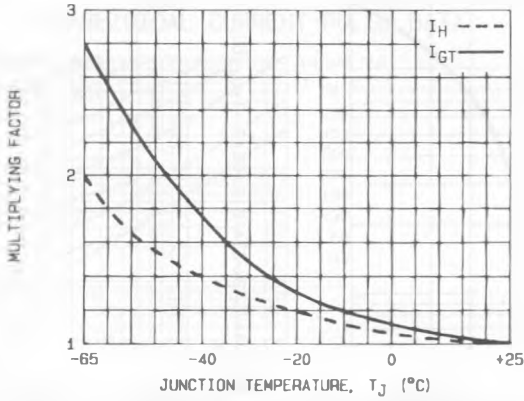


FIG.10 - RELATIVE VARIATION OF GATE TRIGGER CURRENT AND HOLDING CURRENT VERSUS JUNCTION TEMPERATURE.

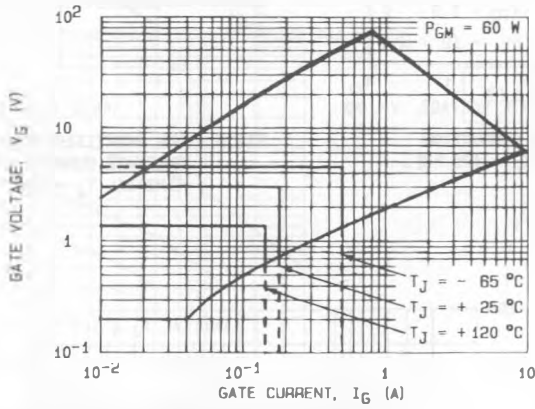


FIG.11 - GATE TRIGGER CHARACTERISTICS.

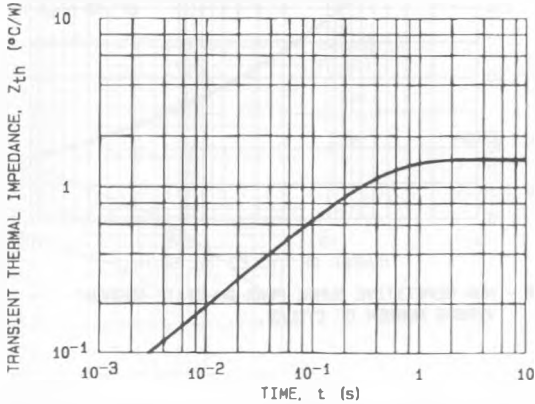


FIG.12 - TRANSIENT THERMAL IMPEDANCE JUNCTION TO CASE.